

Innovative **Technology**for a **Connected** World

UltraTEC™ Series UT9,28,F2,4040

Thermoelectric Module



The UltraTEC™ Series is a high heat pumping density thermoelectric module (TEM). The module is assembled with a large number of semiconductor couples to achieve a higher heat pumping capacity than standard single stage TEMs.

This product line is available in multiple configurations and is ideal for applications that require higher cooling capacities with limited surface area. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics, the UltraTEC™ Series is designed for higher current and larger heat-pumping applications.

FEATURES **FROHS**

- High heat pump density
- Precise temperature control
- Reliable solid state operation
- No sound or vibration
- DC operation
- RoHS compliant

APPLICATIONS

- Analytical instrumentation
- Clinical diagnostics
- Photonics laser systems
- Electronic enclosure cooling
- Food and beverage cooling
- Chillers (liquid cooling)

PERFORMANCE SPECIFICATIONS					
Hot side temperature (°C) 25					
Qmax (watts)	206				
Delta Tmax (°C)	68				
Imax (amps)	9.2				
Vmax (volts)	36.7				

SUFFIX	THICKNESS	FLATNESS & PARALLELISM	HOT FACE	COLD FACE	LEAD LENGTH
TA	0.110" +/- 0.001"	0.0008" / 0.0016"	Lapped	Lapped	6.0"
	2.80 +/- 0.02 mm	0.02 mm / 0.04 mm	Lapped	Lapped	152.4 mm

SEALING OPTION

SUFFIX	SEALANT	COLOR	TEMP RANGE	DESCRIPTION
RT	RTV	White	-60 to 204 °C	Non-corrosive, silicone adhesive sealant
EP	Ероху	Black	-55 to 150 °C	Low density syntactic foam epoxy encapsulant

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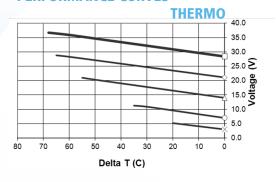


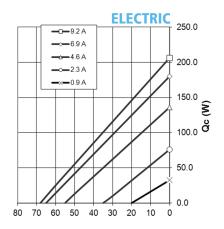
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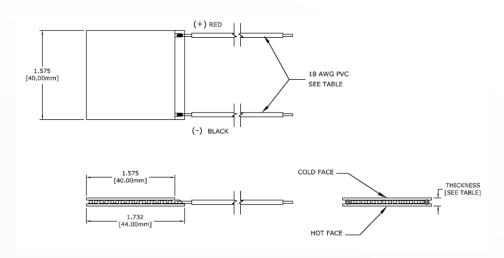
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PERFORMANCE CURVES





MECHANICAL DRAWING



Ceramic Material 96% Alumina Ceramics Solder Construction: 138°C BiSn

OPERATING TIPS

- Max operating temperature: 80°C
- Do not exceed Imax or Vmax when operating module
- Reference assembly guidelines for recommended installation

THR-DS-UT9,28,F2,4040 1011

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